PROCEEDINGS OF SPIE

Thermosense: Thermal Infrared Applications XLV

Nicolas P. Avdelidis *Editor*

2–4 May 2023 Orlando, Florida, United States

Sponsored by SPIE

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Published by SPIE

Volume 12536

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Please use the following format to cite material from these proceedings: Author(s), "Title of Paper," in *Thermosense: Thermal Infrared Applications XLV*, edited by Nicolas P. Avdelidis, Proc. of SPIE 12536, Seven-digit Article CID Number (DD/MM/YYYY); (DOI URL).

ISSN: 0277-786X

ISSN: 1996-756X (electronic)

ISBN: 9781510661868

ISBN: 9781510661875 (electronic)

Published by

SPIE

P.O. Box 10, Bellingham, Washington 98227-0010 USA Telephone +1 360 676 3290 (Pacific Time)

SPIE.org

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